



3A SBR SUPER BARRIER RECTIFIER PowerDI

Product Summary

V _{RRM} (V)	I _O (A)	V _F Max (V)	I _R Max (μA)		
60	3	0.62	100		

Description

The SBR3U60P1Q is a single rectifier in the PowerDI[®]123 package, offering excellent high-temperature stability and low forward voltage.

Applications

- Bridge Diodes
- Flyback Diodes
- Blocking Diodes
- Reverse Protection Diodes

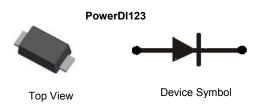
Features and Benefits

- Ultra-Low Forward Voltage Drop
- Low Reverse Leakage Current
- Patented Super Barrier Rectifier SBR[®] Technology
- Patented Interlocking Clip Design for High Surge Current Capacity
- Soft, Fast Switching Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- The SBR3U60P1Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: PowerDI123
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Matte Tin Finish Annealed over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (@)
- Weight: 0.018 grams (Approximate)



Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
SBR3U60P1Q-7	Automotive	PowerDI123	3,000/Tape & Reel
SBR3U60P1Q-13	Automotive	PowerDI123	10,000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information



3U6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	2018	8	2019		2020	20	21	2022		2023	2	2024
Code	F		G		Н			J		К		L
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}		
Working Peak Reverse Voltage	VRWM	60	V
DC Blocking Voltage	V _{RM}		
RMS Reverse Voltage	V _{R(RMS)}	42	V
Average Rectified Output Current	lo	3.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	80	A
Repetitive Peak Avalanche Energy (1µs, +25°C)	PARM	2,100	W

Thermal Characteristics (Note 8)

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Soldering (Note 6) Thermal Resistance Junction to Ambient (Note 5)	R _{θJS} R _{θJA}	5 125	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

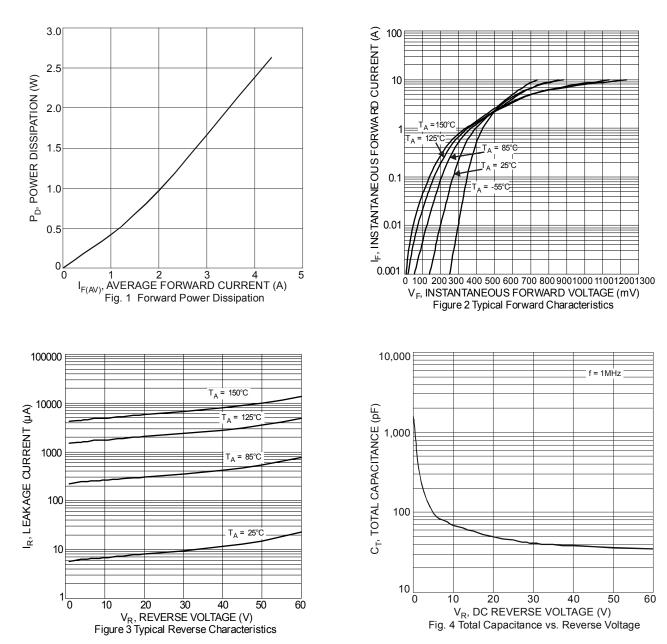
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	VF	_		0.62	V	I _F = 3.0A, T _J = +25°C
Forward Voltage Drop	VF	_		0.61	V	I _F = 3.0A, T _J = +125°C
Leakage Current (Note 7)	I _R	_	_	100	μA	V _R = 60V, T _J = +25°C
Leakage Current (Note 7)	I _R		_	12	mA	V _R = 60V, T _J = +125°C

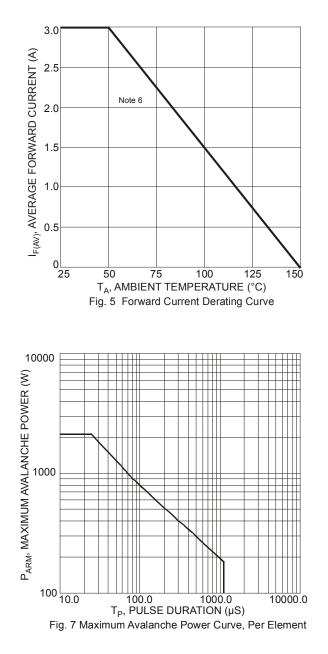
 FR-4 PCB, 2 oz. copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
Theoretical R_{BJS} calculated from the top center of the die straight down to the PCB cathode tab solder junction
Short duration pulse test used to minimize self-heating effect. Notes:

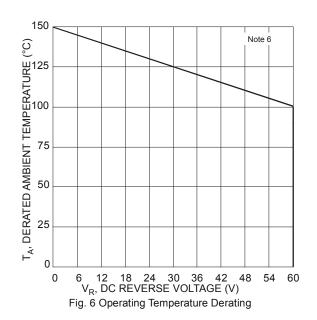
8. The heat generated must be less than thermal conductivity from junction-to-ambient: dPD/DTJ < 1/RthJA







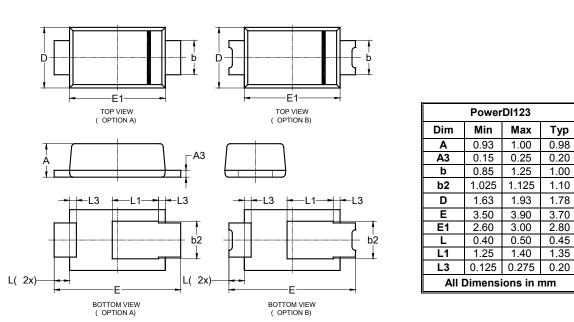






Package Outline Dimensions

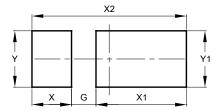
Please see http://www.diodes.com/package-outlines.html for the latest version.



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123



Dimensions	Value (in mm)
G	0.65
Х	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50



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